



## Final Product Change Notification

202308003F01 : i.MX 8QuadMax, i.MX 8QuadPlus Final Test Site Expansion from NXP-ATTJ-B2 to ASE-KH

**Note:** This notice is NXP Company Proprietary.

**Issue Date:** Sep 26, 2023 **Effective date:** Dec 25, 2023

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For detailed information we invite you to [view this notification online](#)

### Management summary

i.MX 8QuadMax, i.MX 8QuadPlus Final Test Site Expansion from NXP-ATTJ-B2 to ASE-KH

### Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Process	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Equipment	<input type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input checked="" type="checkbox"/> Packing/Shipping/Labeling	<input checked="" type="checkbox"/> Test Location	<input type="checkbox"/> Electrical spec./Test coverage
<input type="checkbox"/> Firmware <input type="checkbox"/> Other				

## PCN Overview

### Description

NXP Semiconductors announces the Final Test site expansion for i.MX 8QuadMax, i.MX 8QuadPlus products from the current NXP-ATTJ-B2, Tianjin, China Final Test site to the ASE, Kaohsiung, Taiwan Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01, SEM-PS-03

### Reason

Qualification of ASE, Kaohsiung, Taiwan Final Test site is required for manufacturing flexibility and customer supply assurance.

### Identification of Affected Products

Product identification does not change

### Product Availability

### Sample Information

Samples are available from Sep 22, 2023

Pls contact with Sales team for sample delivery.

**Production**

Planned first shipment Dec 25, 2023

**Anticipated Impact on Form, Fit, Function, Reliability or Quality**

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No Impact on form, fit, function, reliability or quality

**Disposition of Old Products**

Site Expansion, no inventory depletion is needed.

**Additional information**

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Self qualification: [view online](#)

Additional documents: [view online](#)

**Timing and Logistics**

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In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Oct 26, 2023.

**Contact and Support**

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For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

**About NXP Semiconductors**

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